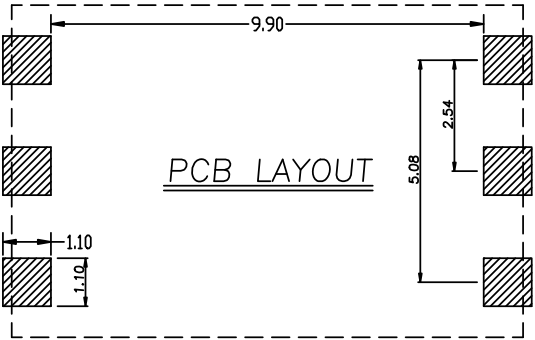
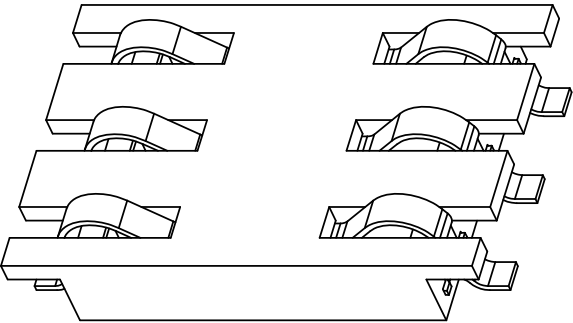
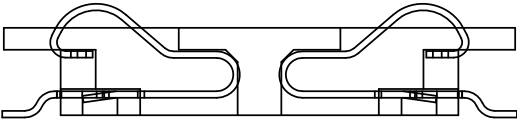
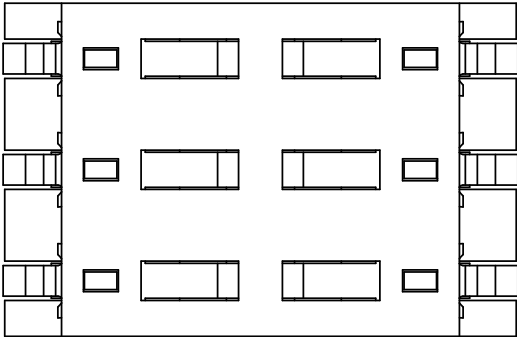
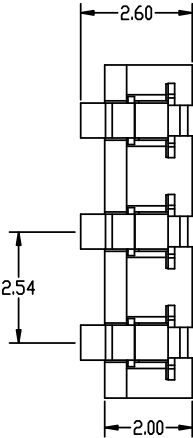
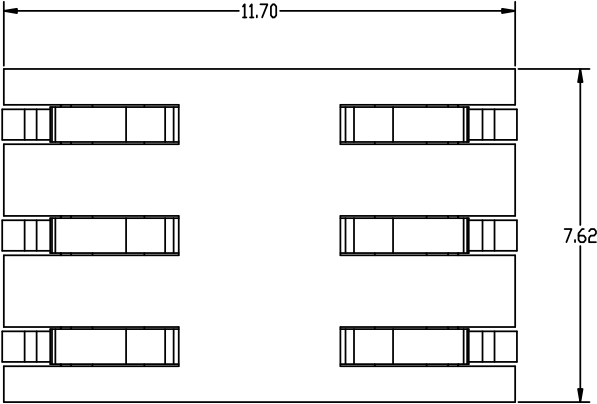


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更改 REV	設 變 內 容 MODIFICATION	日 期 DATE	修 改 DRAW



MATERIAL:
INSULATION: LCP (BLACK)
CONTACT: COPPER ALLOY
PLATING: SELECTED 15u" GOLD
OVER NICKEL 50u"

DIMENSION IN mm [Inch]			C	
TOLERANCE UNLESS OTHERWISE SPECIFIED			康茂股份有限公司 COMMA ELECTRONIC INC.	
.X±0.3	X*± 1°	審 核 APPROVE	名稱 TITLE	簡易式SIMCARD
.XX±0.20	.X*± 0.5°	核 對 CHECK	案 號 FILE NO.	SCS2.54-6106
.XXX±0.100	.XX*± 0.25°	製 圖 DRAW	圖 號 DWG NO.	SCS2.54-6106
			圖紙 SIZE	A4
			角法 PROJ.	1:1
			比例 SCALE	1:1
			張數 SHEET	1
			更改 REV	XA

1 2 3 4 5 6 7 8

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